# **Specification SSC-FCW302**

SSC		Customer		
Drawn	Approval	Approval		

Rev. 0.00

September 2009

# [Contents]

- 1. Features
- 2. Absolute maximum ratings
- 3. Electro-optical characteristics
- 4. Graphs
- 5. Soldering profile
- 6. Outline dimension
- 7. Reel dimension
- 8. Precaution for use



# 1. Features

Package: 3.5 × 2.8 × 0.85 mm

Applications : Mobile Handset Flash Light

# 2. Absolute maximum ratings

(Ta=25°C)

Parameter	Symbol	Value	Unit	
Power Dissipation	$P_d$	1020	mW	
Forward Current	I <sub>F</sub>	300	mA	
Peak Forward Current	I <sub>FM</sub> *1	1000	mA	
Reverse Voltage	$V_R$	5	V	
Operation Temperature	T <sub>opr.</sub>	-30 ~ 80	°C	
Storage Temperature	T <sub>stg.</sub>	-40 ~ 100	°C	

<sup>\*1</sup> I<sub>FM</sub> conditions: Pulse width T<sub>w</sub>≤300ms and Duty ratio≤1/10

# 3. Electro-Optical Characteristics

(Ta=25°C)

Parameter	Symbol	Condition		Min	Тур	Max	Unit
Forward Voltage	$V_{F}$	I <sub>F</sub> =300 <sup>mA</sup>		-	3.4	-	V
Zener Forward Voltage	$V_{F(z)}$	I <sub>F</sub> =10 <sup>mA</sup>		0.6	-	1.5	V
Luminous Flux* <sup>1</sup>	L <sub>F</sub>	FCW302A	I <sub>F</sub> =300 mA	48	60	-	- Im
			I <sub>F</sub> =1000 <sup>mA</sup> (Flash mode) <sup>2</sup>	130	160	-	
		FCW302B	I <sub>F</sub> =300 mA	63	79	-	
			I <sub>F</sub> =1000 <sup>mA</sup> (Flash mode) <sup>2</sup>	180	190	-	
Chromaticity Coordinates	Х	I <sub>F</sub> =300 mA		-	0.3226	-	
	Y	I <sub>F</sub> =300 mA		-	0.3306	-	
Color Temperature	ССТ	I <sub>F</sub> =300 mA		-	5900	-	K
Viewing Angle	2θ <sub>1/2</sub>	I <sub>F</sub> =300 mA		-	120	-	٥

<sup>\*1</sup> Luminous Flux is measured in integrating sphere

[Note] ( Tolerance : IV  $\pm$ 10%, color coordinate  $\pm$ 0.01, V<sub>F</sub>  $\pm$ 0.1 )

Rev. 0.00

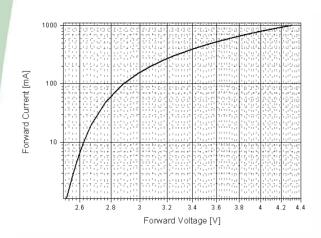
September 2009

<sup>\*2</sup> Flash mode is Pulse width Tw ≤ 300ms, Duty Ratio 1/10

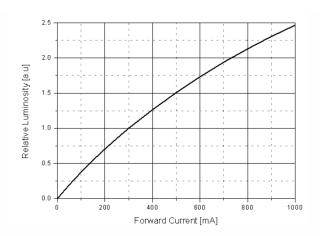


# 4. Graphs

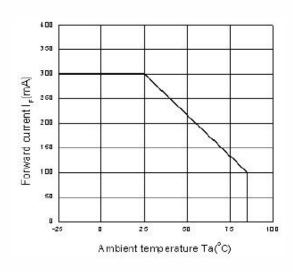
#### Forward Current vs. Forward Voltage



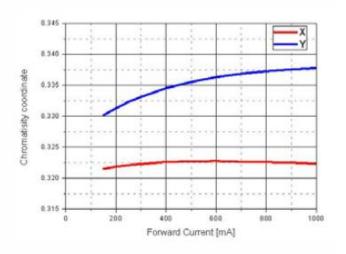
#### **Luminous Intensity vs. Forward Current**



#### **Forward Current Derate Curve**

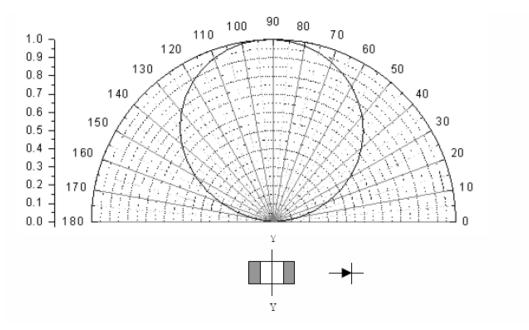


# **Forward Current vs. Chromaticity Coordinate**

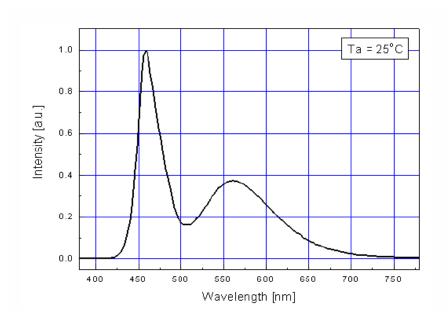




# **Radiation Diagram**



# **Spectrum**



Rev. 0.00

September 2009

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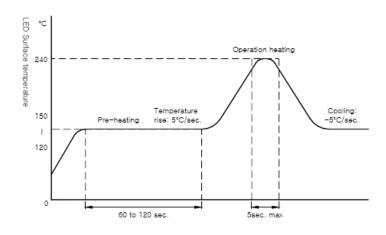


# 5. Soldering Profile

Reflow Soldering Conditions/ Profile

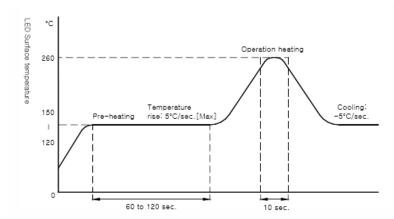
#### (1) Lead Solder

- Preliminary heating to be at 150 °C max. for 2 minutes max.
- Soldering heat to be at 240 °C max. for 5 seconds max.



#### (2) Lead-Free Solder

- Preliminary heating to be at 150 °C max. for 2 minutes max.
- Soldering heat to be at 260 °C max. for 10 seconds max.



#### (3) Hand Soldering Condition

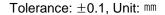
• Not more than 1 seconds @MAX280 °C, under Soldering iron.

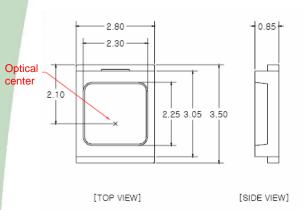
[Note] In case the soldered products are reused in soldering process, Seoul Semiconductor can not guarantee the performance of the products.

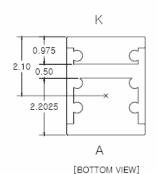
Rev. 0.00

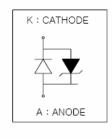


# 6. Outline Dimension



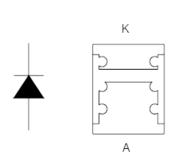


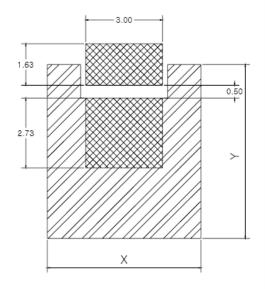




[INNER CIRCUIT]

# \* Recommend solder pad pattern







Soldering Area

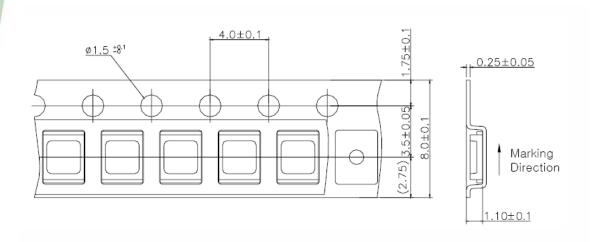


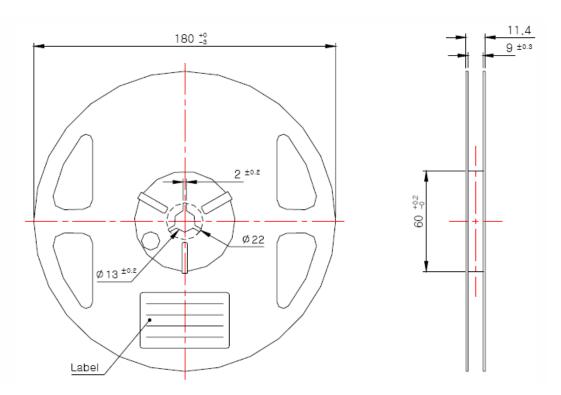
Heat dissipation Area (Cu)



#### 7. Reel Dimension

Tolerance: ±0.2, Unit: mm





- 1) Quantity: 2000pcs/Reel
- 2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be  $\pm 0.2$ mm
- 3) Adhesion Strength of Cover Tape : Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at 10  $^{\circ}$ C angle to be the carrier tape
- 4) Package: P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package

Rev. 0.00



# 8. Precaution for Use

#### Storage

To avoid absorption of moisture, it is recommended to store parts in a dry box (or desiccator) with a desiccant. Otherwise, storage in the following environment is recommended.

Temperature : 5 °C ~ 30 °C Humidity : 60%HR max.

- 2. Parts stored more than one week after opening or if desiccant indicator shower color changes, it is highly recommended that LED's should be baked for 10~ 12 hours at 60°C±5°C
- 3. LEDs must be stored at clean atmosphere. If the LEDs are stored for 3 months or more after shipment from SSC, storage in a sealed container with a nitrogen is recommended.
- 4. If the LED is considered to be wet, it is highly recommended that the LED should be dried for 100Hr at 80±5℃ or 12Hr at 100±5℃.
- 5. Any mechanical force or excess vibration should be avoided during temperature cooling process to normal temperature after reflow
- 6. Rapid cooling should be avoided
- 7. LED should not be placed on a flexible area of the PCB
- 8. This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA should be used.
- 9. When the LED is operating in DC mode, the driving current should be determined after considering the thermal properties of the application and maximum ambient temperature requirements
- 10. Damage prevention from ESD or Surge.
  - 1. It is highly recommended to use the wrist-band or anti electrostatic gloves when handling the LED's
  - 2. All devices, equipments and machines mush be properly grounded

Rev. 0.00